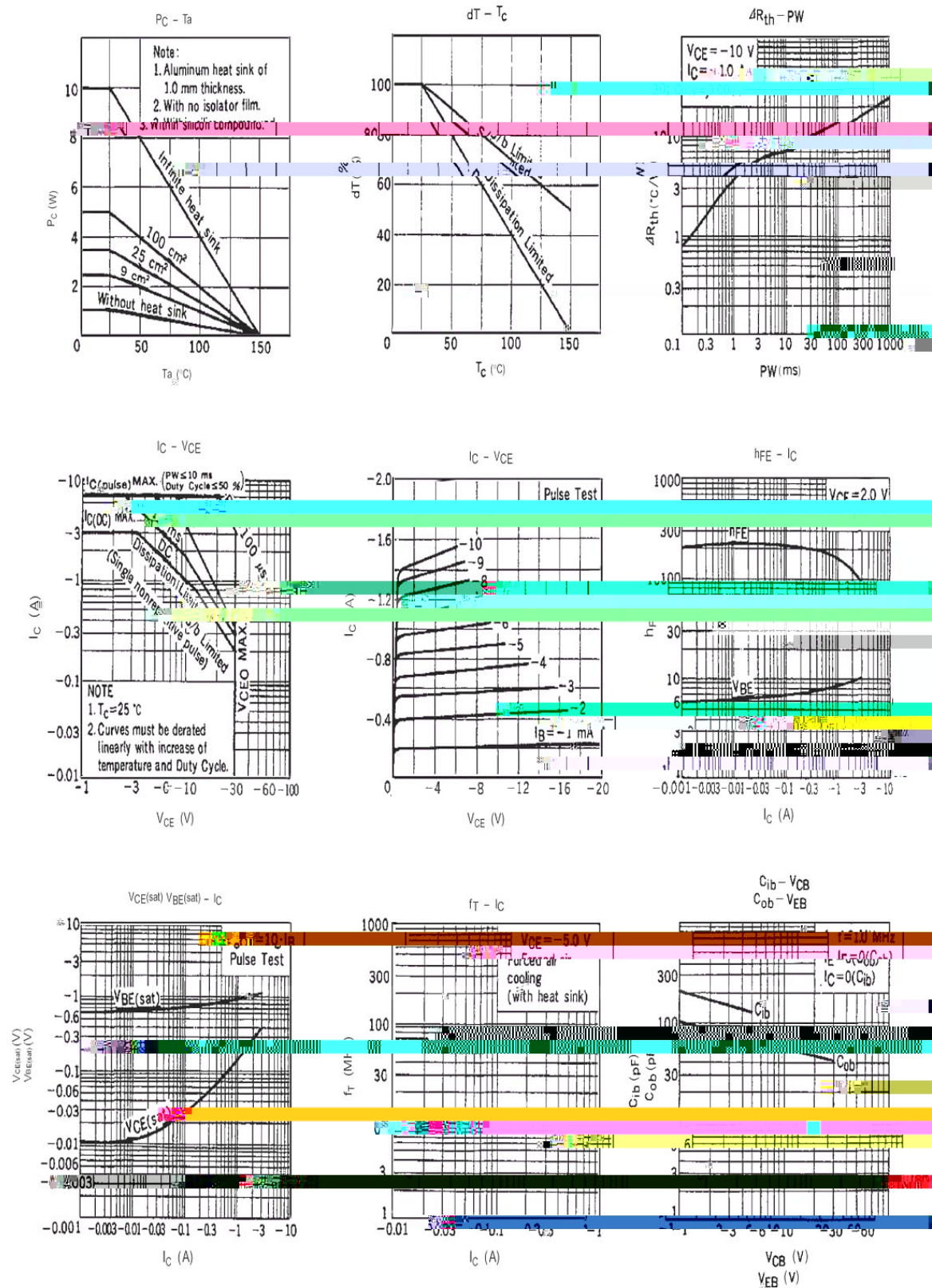


2SB772N
Rev.E Mar.-2016

/ Electrical Characteristic Curve



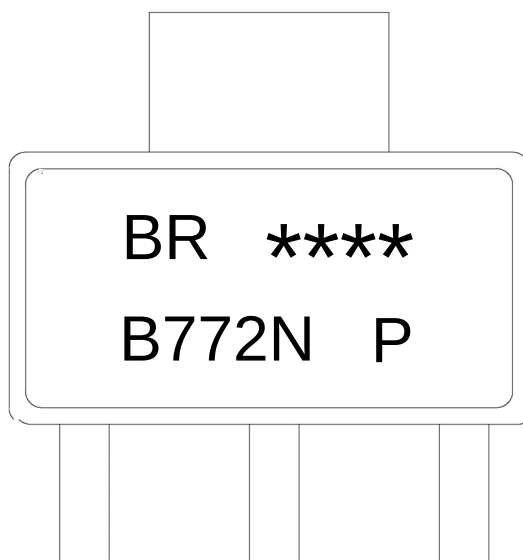
SQT-223
单位: mm

The drawing shows a mechanical component with the following dimensions and features:

- A**: Overall width of the top flange.
- a**: Width of the central slot in the top flange.
- B**: Height of the main body.
- L**: Total height of the component.
- C**: Width of the base flange.
- L1**: Thickness of the base flange.
- 1, 2, 3**: Three vertical mounting holes on the front face.
- a1**: Distance from the left edge to the center of the first hole.
- E**: Distance between the centers of the first and second holes.
- E1**: Total distance between the centers of the first and third holes.
- Detail View**: A circular detail of a corner with dimensions **D** (radius), **H** (height), **C** (width), **K** (fillet radius), and **R** (corner radius).

Dimensions In Millimeters		Dimensions In Millimeters	
Symbol	Value	Symbol	Value
A	100	C	50
a	40	L1	10
B	30	D	15
L	80	H	20
1	10	C	50
2	10	K	5
3	10	R	10
a1	20		
E	30		
E1	60		

/ Marking Instructions



BR

B772N

P

h_{FE}

Note:

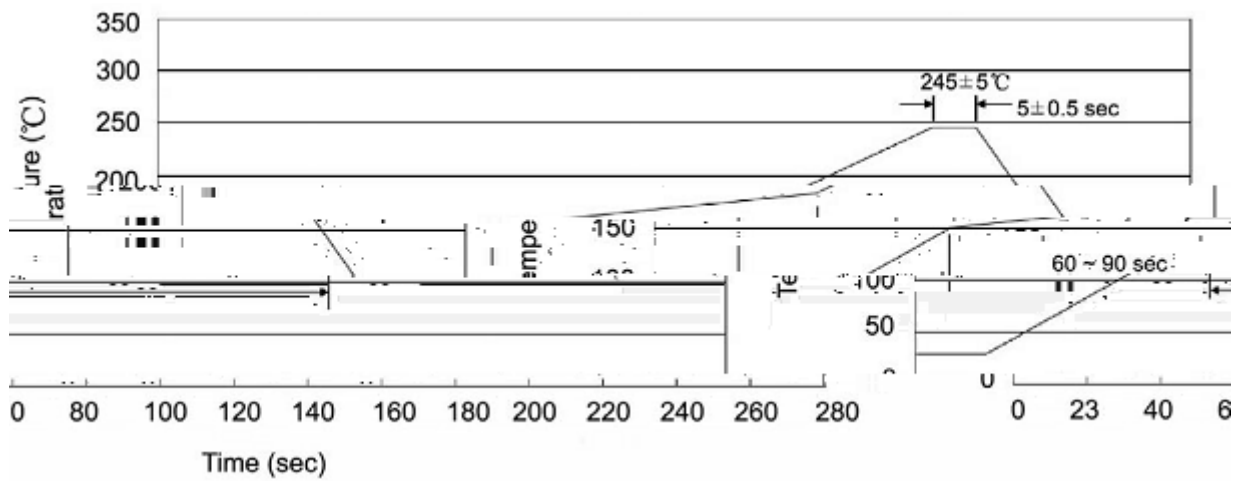
BR: Company Code.

B772N: Product Type.

P: h_{FE} Classifications Symbol

****: Lot No. Code, code change with Lot No.

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- | | | | | | |
|---|-----|-----|----|----------|---|
| 1 | 25 | 150 | 60 | 90sec; | 1.Preheating:25~150 , Time:60~90sec. |
| 2 | 245 | 5 | 5 | 0.5sec; | 2.Peak Temp.:245 5 , Duration:5 0.5sec. |
| 3 | | | 2 | 10 /sec. | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

260 5 10 1 sec. Temp:260±5 Time:10±1 sec

/ Packaging SPEC.

/ REEL